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Bib Data Sheet

CONFIRMATION NO. 2815

|                                    |   |                     |                               |  |
|------------------------------------|---|---------------------|-------------------------------|--|
| <b>SERIAL NUMBER</b><br>09/904,839 | <b>FILING DATE</b><br>07/16/2001<br><b>RULE</b> | <b>CLASS</b><br>257 | <b>GROUP ART UNIT</b><br>2814 | <b>ATTORNEY DOCKET NO.</b><br>501.35250CX3 |
|------------------------------------|---|---------------------|-------------------------------|--|

## APPLICANTS

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## \*\* CONTINUING DATA \*\*\*\*\*

THIS APPLICATION IS A CON OF 08/820,228 03/18/1997 PAT 6,265,762

## \*\* FOREIGN APPLICATIONS \*\*\*\*\*

JAPAN 9-008964 01/21/1997  
JAPAN 8-060421 03/18/1996

yes

## IF REQUIRED, FOREIGN FILING LICENSE GRANTED

\*\* 08/29/2001

|   |                           |                      |                   |                         |
|---|---------------------------|----------------------|-------------------|-------------------------|
| Foreign Priority claimed<br><input checked="" type="checkbox"/> yes <input type="checkbox"/> no   | STATE OR COUNTRY<br>JAPAN | SHEETS DRAWING<br>10 | TOTAL CLAIMS<br>6 | INDEPENDENT CLAIMS<br>1 |
| 35 USC 119 (a-d) conditions met<br><input type="checkbox"/> yes <input checked="" type="checkbox"/> no <input type="checkbox"/> Met after Allowance |                           |                      |                   |                         |
| Verified and Acknowledged<br><i>Da Shin</i> 9/16/04<br>Examiner's Signature Initials  |                           |                      |                   |                         |

## ADDRESS

020457

## TITLE

Lead frame and semiconductor device using the lead frame and method of manufacturing the same

|                                   |   |   |
|-----------------------------------|---|---|
| <b>FILING FEE RECEIVED</b><br>710 | FEES: Authority has been given in Paper<br>No. _____ to charge/credit DEPOSIT ACCOUNT<br>No. _____ for following: | <input type="checkbox"/> All Fees<br><input type="checkbox"/> 1.16 Fees ( Filing )<br><input type="checkbox"/> 1.17 Fees ( Processing Ext. of time )<br><input type="checkbox"/> 1.18 Fees ( Issue )<br><input type="checkbox"/> Other _____<br><input type="checkbox"/> Credit |
|-----------------------------------|---|---|